

ABSTRACT

A molded body that can suppress plastic deformation during conveyance is provided. A molded body according to the present disclosure is
5 a molded body containing a sinterable inorganic powder and an organic binder, wherein the bending modulus (MPa) upon 0.05% to 0.1% strain of the above molded body is 4000 to 15000, and the bending yield strength (MPa) is 10 or more.

10 [No figure]